

Is Now Part of

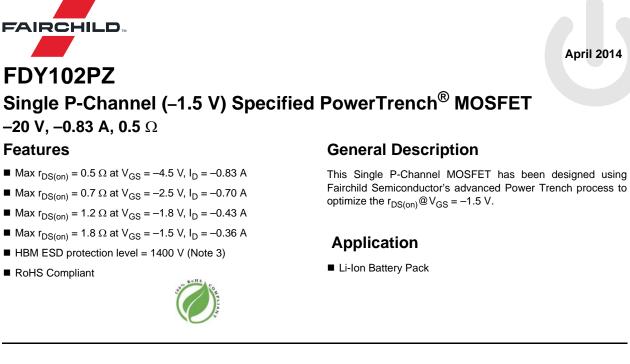


ON Semiconductor®

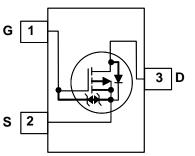
To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdicii on or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor reducts for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, and filiates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended o



S G SC89-3



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V _{DS}	Drain to Source Voltage		-20	V	
V _{GS}	Gate to Source Voltage		±8	V	
I _D	Drain Current -Continuous	(Note 1a)	-0.83	^	
	-Pulsed		-1.0	— A	
P _D	Power Dissipation	(Note 1a)	0.625		
	Power Dissipation	(Note 1b)	0.446		
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C	

Thermal Characteristics

R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1a)	200	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1b)	280	C/W

Package Marking and Ordering Information

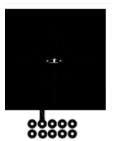
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
E	FDY102PZ	SC89-3	7 "	8 mm	3000 units

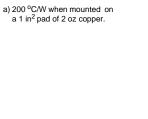
April 2014

©2008 Fairchild Semiconductor Corporation FDY102PZ Rev.B3

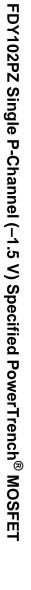
Downloaded from Arrow.com.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_{D} = -250 \ \mu A, \ V_{GS} = 0 \ V$	-20			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, referenced to 25 °C		-11		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -16 \text{ V}, V_{GS} = 0 \text{ V}$			-1	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 8 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 5 \text{ V}, V_{DS} = 0 \text{ V}$			±0.5	μA
On Chara	acteristics (Note 2)					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = -250 μA	-0.4	-0.7	-1.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, referenced to 25 °C		3		mV/°C
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -0.83 \text{ A}$		0.28	0.5	Ω
		$V_{GS} = -2.5 \text{ V}, \text{ I}_{D} = -0.70 \text{ A}$		0.36	0.7	
r	Static Drain to Source On-Resistance	$V_{GS} = -1.8 \text{ V}, I_D = -0.43 \text{ A}$		0.47	1.2	
r _{DS(on)}	State Drain to Source On-Resistance	$V_{GS} = -1.5 \text{ V}, \text{ I}_{D} = -0.36 \text{ A}$		0.62	1.8	
		$V_{GS} = -4.5 \text{ V}, I_D = -0.83 \text{ A}, T_J = 125 \text{ °C}$		0.39	0.85	
9 _{FS}	Forward Transconductance	$V_{DD} = -5 \text{ V}, \text{ I}_{D} = -0.83 \text{ A}$		2		S
Dvnamic	Characteristics					
C _{iss}	Input Capacitance			100	135	pF
C _{oss}	Output Capacitance	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		23	35	pF
C _{rss}	Reverse Transfer Capacitance	f = 1 MHz		18	30	pF
					1	
	g Characteristics (Note 2)			0.5	10	
t _{d(on)}	Turn-On Delay Time			3.5	10	ns
t _r	Rise Time	$V_{DD} = -10 \text{ V}, I_D = -0.83 \text{ A}$		2.9	10	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = -4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		23	37	ns
t _f	Fall Time			13	23	ns
Q _g	Total Gate Charge	V _{DD} = -10 V, I _D = -0.83 A		2.2	3.1	nC
Q _{gs}	Gate to Source Charge Gate to Drain "Miller" Charge	$-V_{GS} = -4.5 V$		0.3		nC nC
Q _{gd}	Gale to Drain Willer Charge			0.6		nc
Drain-So	urce Diode Characteristics and M	laximum Rating				
I _S	Maximum Continuous Drain-Source Diode	e Forward Current			-0.52	Α
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = -0.52 A$ (Note 2)		-1.0	-1.2	V
t _{rr}	Reverse Recovery Time	I _F = –0.83 A, dI _F /dt = 100 A/μs		18	31	ns
	Reverse Recovery Charge	$\mu_{\rm F} = 0.05 \Lambda$, $\mu_{\rm F} \mu_{\rm C} = 100 \Lambda/\mu_{\rm S}$		3.8	10	nC





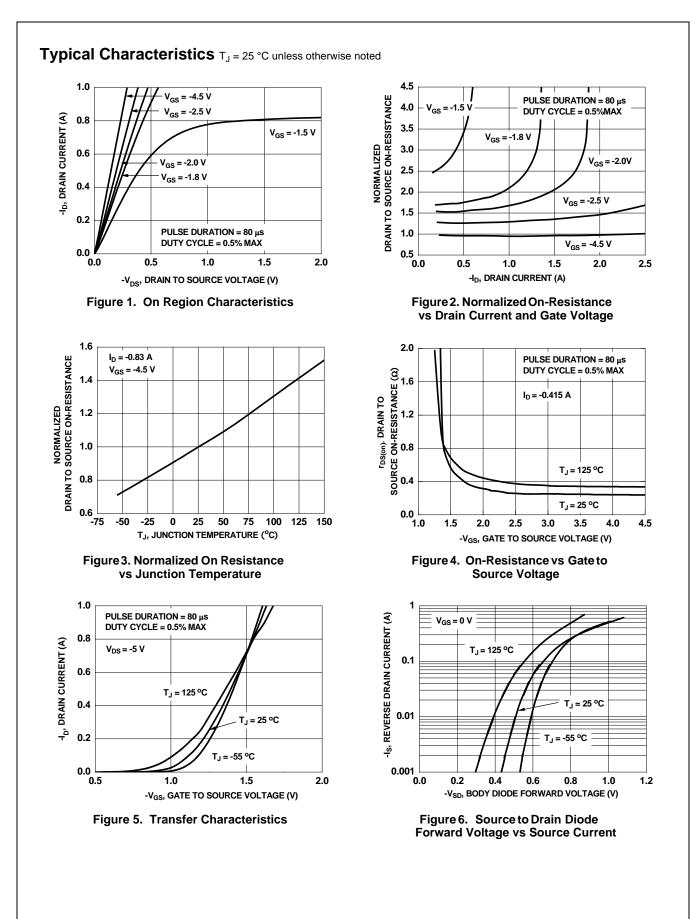
b) 280 °C/W when mounted on a minimum pad of 2 oz copper.



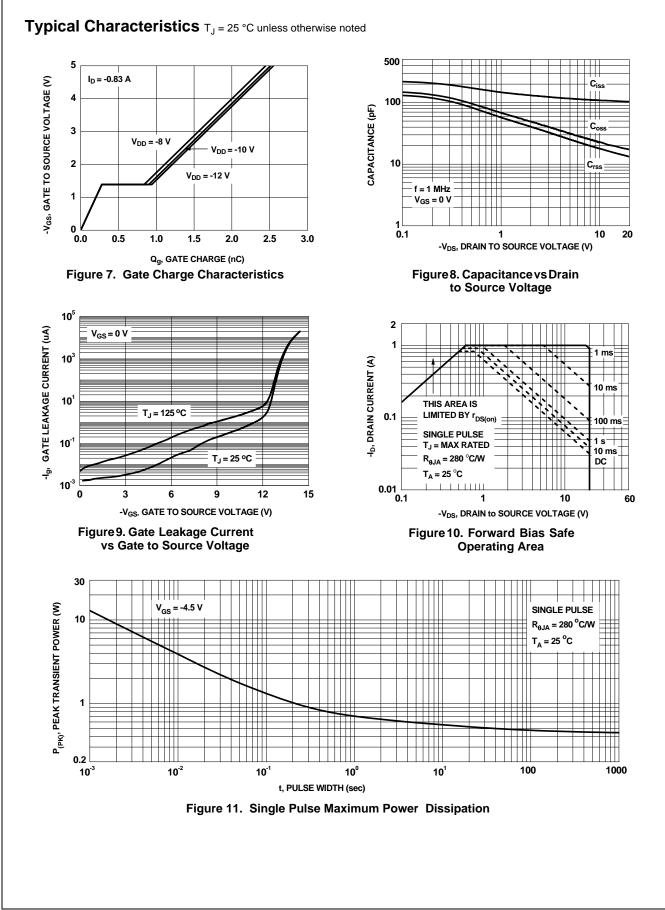
Pulse Test : Pulse Width < 300 us, Duty Cycle < 2.0%
The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

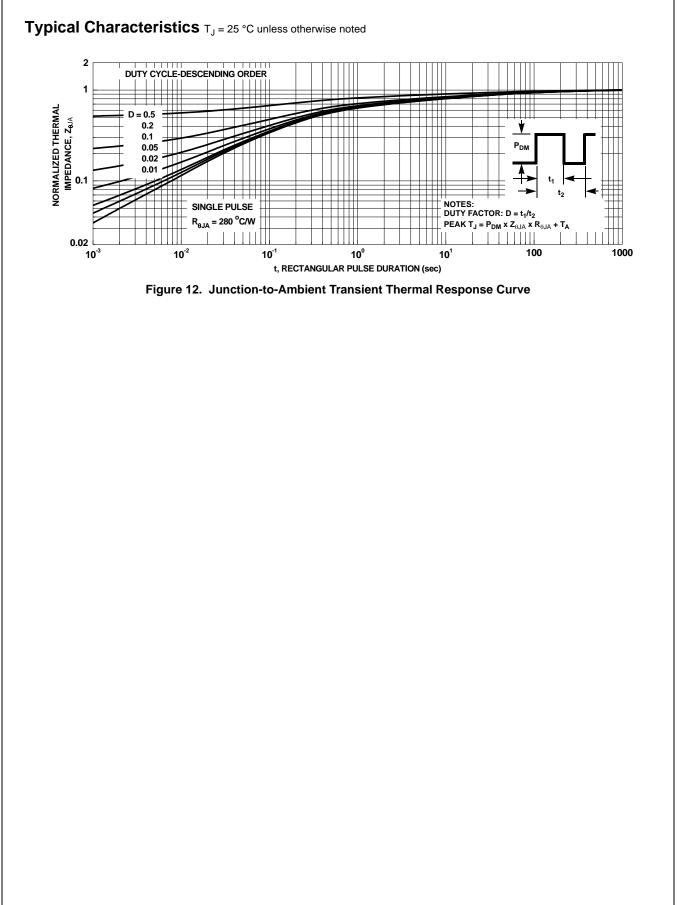
FDY102PZ Rev.B3

ŏŏŏŏ

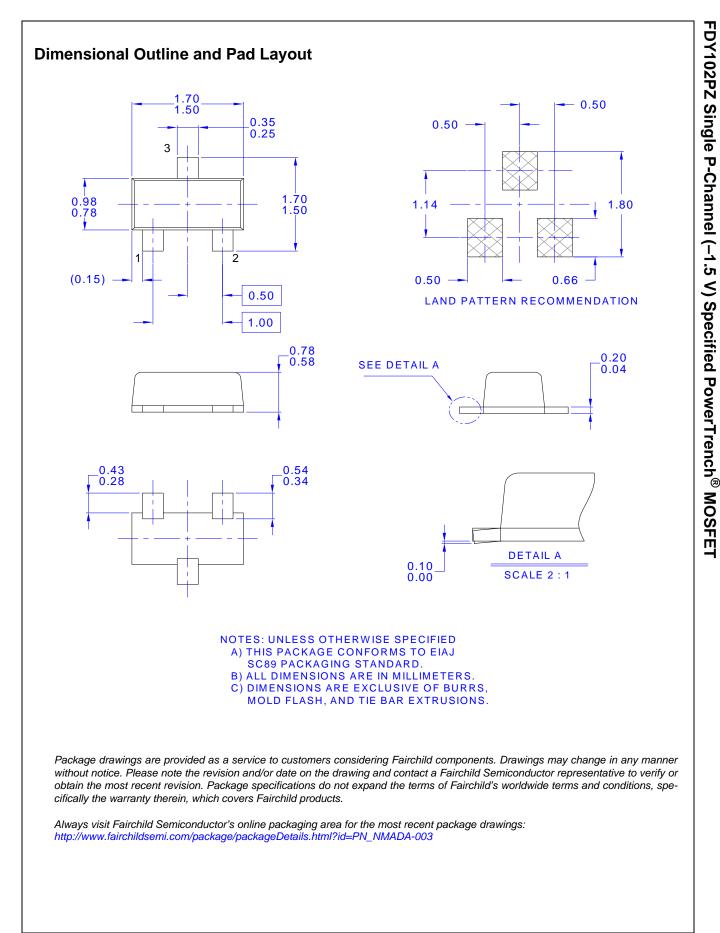


FDY102PZ Rev.B3





FDY102PZ Rev.B3





Downloaded from Arrow.com.

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81–3–5817–1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC

Downloaded from Arrow.com.